

SOLID STATE PRODUCT OUTLINE AND REFLECTS A PRODUCT WITH ANTICIPATED USAGE IN THE ELECTRONICS INDUSTRY; CHANGES ARE LIKELY TO OCCUR.

TITLE 13 Pin Reduced Size MultiMediaCard	PACKAGE DESIGNATOR	ISSUE	DATE		SHEET
(MMC) Outline-MMCmobile 18 X 24 X 1.4mm	RL-PLGA/MMCmobile	А	SEP. 2006	MO-278	1 OF 6

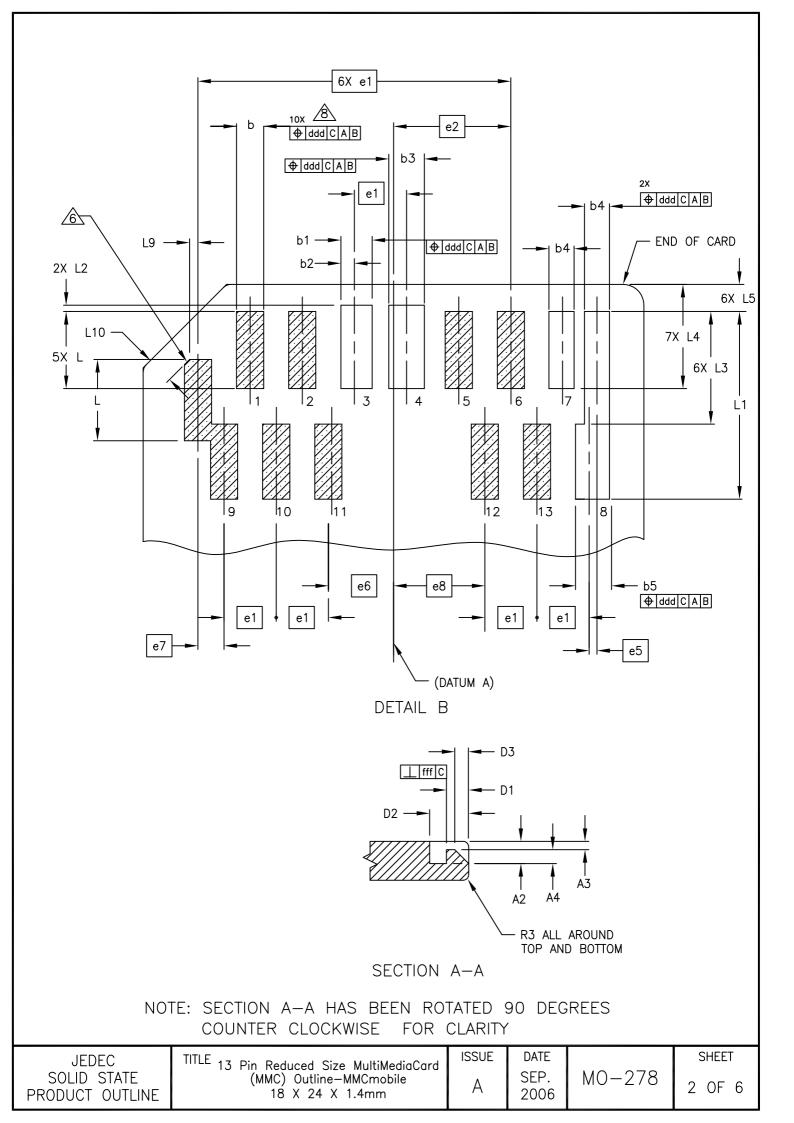


TABLE 1

SYMBOL	MINIMUM	COMMON DIMENS NORMINAL	MAXIMUM	NOTE
Α	1.30	1.40	1.50	
A1	0.70	0.75	0.85	
A2	0.75	0.80	0.85	
A3	0.25	0.30	0.35	
A4	0.45	0.50	0.55	
A5	0.25	0.30	0.35	
A6	0.70	0.75	0.80	
b	1.05	1.30	1.55	
b1	1.25	1.50	1.75	
b2	0.525	0.65	0.775	
b3	1.45	1.70	1.95	
b3	0.95	1.20	1.45	
b5	1.375	1.625	1.875	
	1.373	18.00 BSC	1.673	
	0.75		0.05	
D1	0.75	0.80	0.85	
D2	1.30	1.40	1.50	
D3	0.45	0.50	0.55	
D4	4.90	5.00	5.10	
D5	6.40	6.50	6.60	4
D6	9.90	10.00	10.10	
D7	11.40	11.50	11.60	4
D8	1.90	2.00	2.10	7
E		24.00 BSC		
<u>E</u> 1	0.50	0.55	0.65	
E2			21.675	
E3	1.95			
E4		15.80 BSC		7
E5	8.90	9.00	9.10	7
E6	0.50	17.80 BSC	0.10	7
E7		23.30 BSC		7
e1		2.50 BSC		
e2		5.625 BSC		
<u>e3</u>		8.05 BSC		
<u>e4</u>		9.75 BSC		
e5		0.375 BSC		
<u>e6</u>		3.125 BSC		
<u>e7</u>		1.25 BSC		
e8		4.375 BSC		
Н	3.90	4.00	4.10	5
H1	3.90	4.00	4.10	5
L	3.60	3.70	3.80	
L1	8.90	9.00	9.10	
L2	0.20	0.30	0.40	
L3	5.30	5.40	5.50	
L4	5.00			
L5			1.60	
L6	7.50			
L7			4.00	
L8	2.20	2.30	2.40	
 L9	0.25			6
L10			1.30	6
N N		13	1.00	3
R1	0.45	0.50	0.55	
R2	0.45	1.00	1.05	
			1.05	
R3	0.20			4
R4			0.35	4
R5	0.45	0.50	0.55	
R6	0.20	0.25	0.30	
R7			0.25	4
NOTES		1,2		
REF		11.14-092		
ISSUE		A		

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TABLE 2

	TOLERANCE OF FORM & POSITION
SYMBOL	
aaa	0.10
bbb	0.08
ссс	0.15
ddd	0.05
eee	0.05
fff	0.06
NOTES	1,2
REF	11.14-092
ISSUE	А

NOTES:

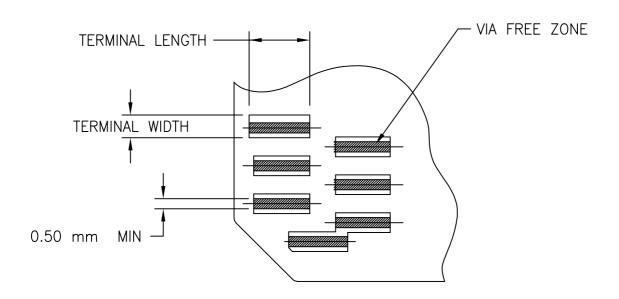
- 1. DIMENSIONS AND TOLERANCING CONFORM TO ASME Y14.5M-1994
- 2. ALL DIMENSIONS IN MILLIMETERS.
- 3. N IS THE NUMBER OF TERMINALS.
- 1 THE RETENTION NOTCH AREAS ARE FOR MECHANICAL LOCKING OF THE CARD.
- 5. CHAMFER IS A MECHANICAL KEY FEATURE.
- 6. CHAMFERED TERMINAL END IS TO ALLOW A NON CONDUCTIVE ZONE BETWEEN THE TERMINAL AND LID.
- 7. FEATURES ARE PRESENT TO ALLOW AN EXTENSION CARD IF DESIRED TO BE ATTACHED TO MAKE THE TOTAL CARD LENGTH COMPATIBLE WITH THE 13 PIN FULL SIZE MULTIMEDIA CARD.
- & CROSS SECTIONED TERMINALS IN DETAIL B ARE TO SHOW THE LEADS THAT HAVE b TERMINAL WIDTH.

APPLICATION NOTES:

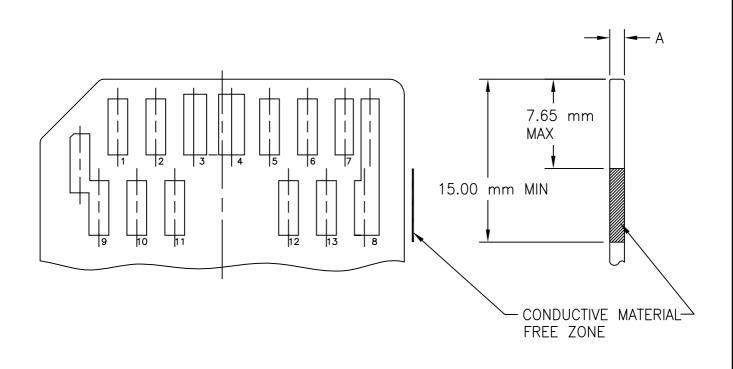
9. PREFERABLE PLATING, ELECTROLYTIC (HARD) GOLD PLATING 0.50 MICROMETERS MINIMUM OVER ELECTROLYTIC NICKEL 2.00 MICROMETERS MINIMUM.

JEDEC	TITLE	47 B' B C'	ISSUE	DATE		SHEET
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PRODUCT OUTLINE		18 X 24 X 1.4mm	, ,	2006		1 01 0

10. WHEN THE CARD IS CONSTRUCTED WITH VIAS IN THE TERMINALS, A VIA FREE KEEP OUT ZONE OF 0.50 mm MINIMUM WIDE (IN THE CENTER OF EACH TERMINAL) AND ALONG THE ENTIRE TERMINAL LENGTH MUST BE OBSERVED (SEE NOTE FIGURE).



11. WHEN THE CARD IS CONSTRUCTED WITH CONDUCTIVE MATERIAL ON THE EXTERNAL CARD SURFACE EDGE, A KEEP OUT ZONE ADJACENT TO TERMINAL 8 MUST BE FREE OF ANY CONDUCTIVE MATERIAL. THE ZONE IS DEFINE 7.65 mm MAXIMUM AND 15.00 mm MINIMUM FROM THE NOTCHED END OF THE CARD APPLIES TO THE ENTIRE THICKNESS "A" OF THE CARD (SEE NOTE FIGURE)



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SHEET

Change Record

If the change involves any words added or deleted (excluding deletion of accidentally repeated words), the change is included. Punctuation changes may or may not be included

Initial Issue:	Date:	Item		
А	SEP. 2006	11.14-092		
	Revision History			
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Issue:	Date:	ltem		
Location:	Changed From:	Changed to:		
Issue:	Date:	ltem		
Location:	Changed From:	Changed to:		

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